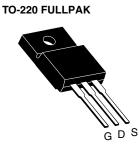
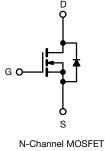


Vishay Siliconix

D Series Power MOSFET





PRODUCT SUMMARY V_{DS} (V) at T_J max. 550 V_{GS} = 10 V R_{DS(on)} max. (Ω) at 25 °C 0.28 76 Q_a max. (nC) 11 Q_{gs} (nC) 17 Q_{gd} (nC) Configuration Single

FEATURES

- Optimal design
- Low area specific on-resistance
- Low input capacitance (Ciss)
- Reduced capacitive switching losses
- High body diode ruggedness
- Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Consumer electronics
- Displays (LCD or Plasma TV)
- Server and telecom power supplies
- SMPS
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF18N50D-E3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	500	
Gate-source voltage			N N	± 30	V
Gate-source voltage AC (f > 1 Hz)			V _{GS}	30	
Continuous drain surrent $(T_{1} - 150 \circ 0)^{\frac{1}{2}}$	V _{GS} at 10 V	T _C = 25 °C		18	
Continuous drain current ($T_J = 150 \ ^\circ C$) e	V _{GS} at 10 V	T _C = 100 °C	I _D	11	А
Pulsed drain current ^a			I _{DM}	53	
Linear derating factor				0.3	W/°C
Single pulse avalanche energy ^b			E _{AS}	115	mJ
Maximum power dissipation			PD	39	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	$T_{\rm J} = 1$	25 °C	dV/dt	24	V/ns
Reverse diode dV/dt ^d			αν/αι	0.4	v/ns
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C
Mounting torque	M3 s	screw		0.6	Nm

Notes

Repetitive rating; pulse width limited by maximum junction temperature $V_{DD} = 50$ V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 10 A a.

b.

1.6 mm from case

d. $I_{SD} \le I_D$, starting $T_J = 25 \text{ °C}$ e. Limited by maximum junction temperature

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1 For technical questions, contact: hvm@vishay.com



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	3.2	0/10

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				1		1	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate threshold voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 100	nA
7		V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V		-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 400 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 9 A	-	0.23	0.28	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 9 A	-	6.4	-	S
Dynamic		•		•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V$,		-	1500	-	-
Output capacitance	C _{oss}		$V_{\rm DS} = 0.0$ V, $V_{\rm DS} = 100$ V,		131	-	
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz		-	14	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V_{GS} = 0 V, V_{DS} = 0 V to 400 V		-	113	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	164	-	
Total gate charge	Qg			-	38	76	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 9 A, V _{DS} = 400 V	-	11	-	nC	
Gate-drain charge	Q _{gd}			-	17	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 400 V, I _D = 9 A,		-	19	38	- ns
Rise time	tr			-	36	72	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		36	72	
Fall time	t _f	1		-	30	60	
Gate input resistance	Rg	f = 1 MHz, open drain		-	1.7	-	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	18	
Pulsed diode forward current	I _{SM}			_	-	72	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 9 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	354	-	ns
Reverse recovery charge	Q _{rr}		$T_J = 25 \text{ °C}, I_F = I_S = 9 \text{ A},$		3.9	-	μC
Reverse recovery current	I _{RRM}	dl/dt = 100 A/μs, V _R = 20 V		-	21	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

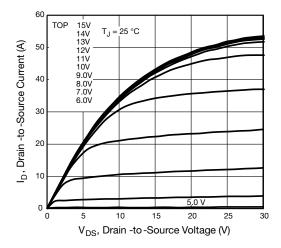


Fig. 1 - Typical Output Characteristics

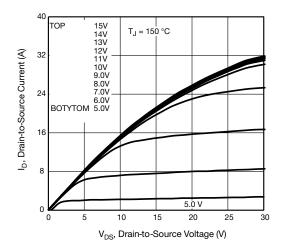
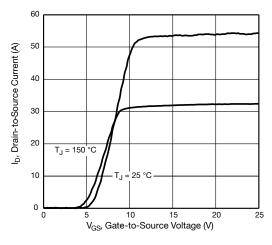


Fig. 2 - Typical Output Characteristics





3 $I_{\rm D} = 9 A$ 2. R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2 1.5 0.5 0 -40 -20 120 140 160 -60 0 20 40 60 80 100 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

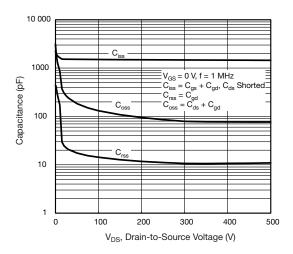


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

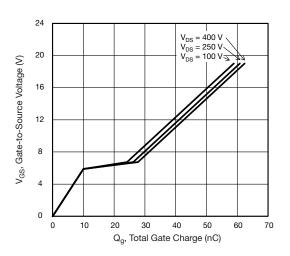


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

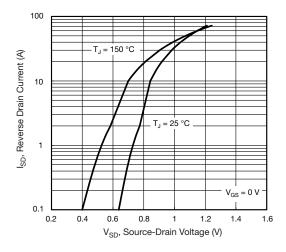
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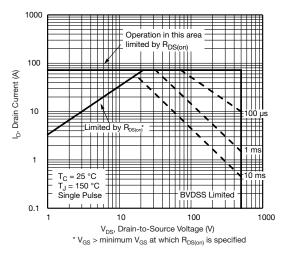


Fig. 8 - Maximum Safe Operating Area

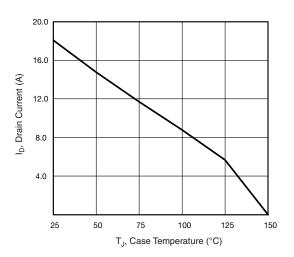


Fig. 9 - Maximum Drain Current vs. Case Temperature

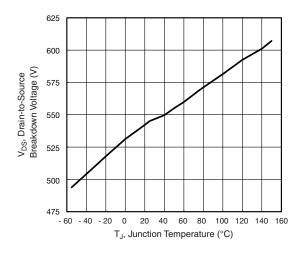


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

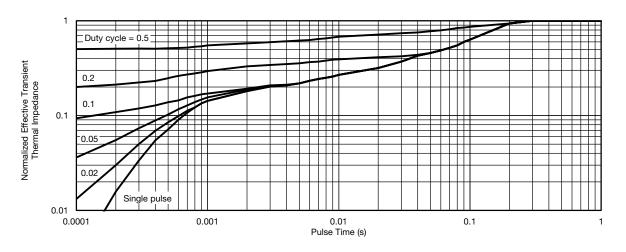


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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4

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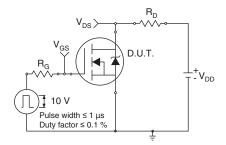


Fig. 12 - Switching Time Test Circuit

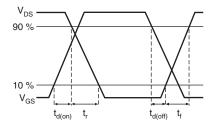


Fig. 13 - Switching Time Waveforms

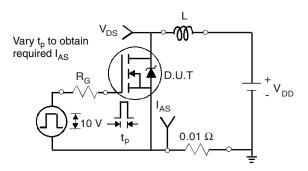


Fig. 14 - Unclamped Inductive Test Circuit

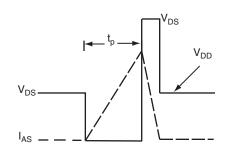


Fig. 15 - Unclamped Inductive Waveforms

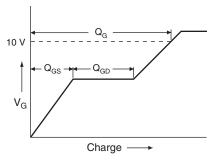


Fig. 16 - Basic Gate Charge Waveform

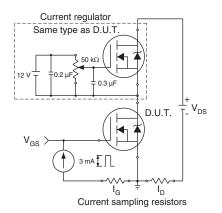
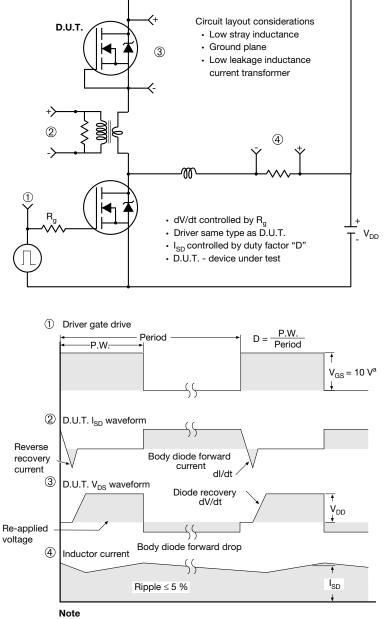


Fig. 17 - Gate Charge Test Circuit

5



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 18 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



	MILLIMETERS		INC	IES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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